



Vincotech

**B0-SL10NIB600S702-PA29F78Z**  
**B0-SL10NIC600S702-PA39F78Z**

datasheet

### flowNPC S3 split

**950 V / 600 A**

#### Features

- High power low inductive package
- Improved R<sub>th</sub> with AlN DCB
- Integrated NTC

#### flow S3 12 mm housing



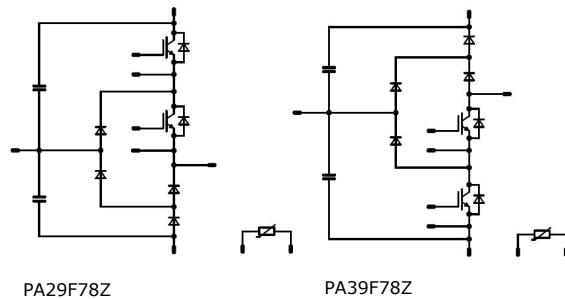
#### Target applications

- Solar Inverters

#### Types

- B0-SL10NIB600S702-PA29F78Z
- B0-SL10NIC600S702-PA39F78Z

#### Schematic





Vincotech

**BO-SL10NIB600S702-PA29F78Z****BO-SL10NIC600S702-PA39F78Z**

datasheet

## Maximum Ratings

$T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
<b>Buck Switch</b>				
Collector-emitter voltage	$V_{CES}$		950	V
Collector current (DC current)	$I_C$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	444	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	1200	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	864	W
Gate-emitter voltage	$V_{GES}$		$\pm 20$	V
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$

## Buck Diode

Peak repetitive reverse voltage	$V_{RRM}$		1200	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	171	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	728	A
Surge (non-repetitive) forward current	$I_{FSM}$	Single Half Sine Wave, $t_p = 10 \text{ ms}$ $T_j = 25^\circ\text{C}$	1040	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	432	W
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$

## Buck Sw. Protection Diode

Peak repetitive reverse voltage	$V_{RRM}$		950	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	77	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	160	W
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$



Vincotech

**B0-SL10NIB600S702-PA29F78Z  
B0-SL10NIC600S702-PA39F78Z**

datasheet

## Maximum Ratings

 $T_j = 25 \text{ }^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
<b>Boost Switch</b>				
Collector-emitter voltage	$V_{CES}$		1200	V
Collector current (DC current)	$I_C$	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	528	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	1200	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	981	W
Gate-emitter voltage	$V_{GES}$		$\pm 20$	V
Short circuit ratings	$t_{SC}$	$V_{GE} = 15 \text{ V}$ , $V_{CC} = 800 \text{ V}$ $T_j = 150 \text{ }^\circ\text{C}$	9,5	$\mu\text{s}$
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$

## Boost Diode

Peak repetitive reverse voltage	$V_{RRM}$		950	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	209	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	413	W
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$

## Boost Sw. Inv. Diode

Peak repetitive reverse voltage	$V_{RRM}$		1200	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	220	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	450	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80 \text{ }^\circ\text{C}$	390	W
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$



Vincotech

**B0-SL10NIB600S702-PA29F78Z  
B0-SL10NIC600S702-PA39F78Z**

datasheet

## Maximum Ratings

 $T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
<b>Boost Sw. Protection Diode</b>				
Peak repetitive reverse voltage	$V_{RRM}$		1200	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$	40	A
Surge (non-repetitive) forward current	$I_{FSM}$	Single Half Sine Wave, $t_p = 10 \text{ ms}$	170	A
Surge current capability	$I_t$	$T_j = 150^\circ\text{C}$	145	$\text{A}^2\text{s}$
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$	113	W
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$

## Boost D. Protection Diode

Peak repetitive reverse voltage	$V_{RRM}$		950	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$	77	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$	160	W
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$

## Capacitor (DC)

Maximum DC voltage	$V_{MAX}$		1000	V
Operation Temperature	$T_{op}$		-55 ... 125	$^\circ\text{C}$

## Module Properties

Thermal Properties				
Storage temperature	$T_{stg}$		-40...+125	$^\circ\text{C}$
Operation temperature under switching condition	$T_{jop}$		-40...+( $T_{jmax} - 25$ )	$^\circ\text{C}$

## Isolation Properties

Isolation voltage	$V_{isol}$	DC Test Voltage	$t_p = 2 \text{ s}$	6000	V
Isolation voltage	$V_{isol}$	AC Voltage	$t_p = 1 \text{ min}$	2500	V
Creepage distance		B0-SL10NIB600S702-PA29F78Z		10.55	mm
		B0-SL10NIC600S702-PA39F78Z		9.93	
Clearance		B0-SL10NIB600S702-PA29F78Z		10.55	mm
		B0-SL10NIC600S702-PA39F78Z		8.06	
Comparative Tracking Index	CTI			$\geq 600$	



## Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$I_D$ [A]	$T_j$ [°C]	Min	

### Buck Switch

#### Static

Gate-emitter threshold voltage	$V_{GE(\text{th})}$	$V_{CE} = V_{GE}$			0,00975	25	4,35	5,1	5,85	V
Collector-emitter saturation voltage	$V_{CE(\text{sat})}$		15		600	25 125 150		1,82 2,07 2,13	2,25 <sup>(1)</sup>	V
Collector-emitter cut-off current	$I_{CES}$		0	950		25			12	µA
Gate-emitter leakage current	$I_{GES}$		20	0		25			300	nA
Internal gate resistance	$r_g$							0,5		Ω
Input capacitance	$C_{res}$	$f = 100 \text{ kHz}$	0	25	25	25	37800		pF	
Output capacitance	$C_{oes}$									
Reverse transfer capacitance	$C_{res}$									
Gate charge	$Q_g$		15		0	25		1350		nC

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{\text{paste}} = 4,4 \text{ W/mK}$ (PTM)						0,11		K/W
--	---------------	--	--	--	--	--	--	------	--	-----

#### Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 2 \Omega$ $R_{goff} = 2 \Omega$	$\pm 15$	600	355	25		211,84		
Rise time	$t_r$					125		214,72		ns
						150		216,32		
Turn-off delay time	$t_{d(off)}$					25		33,6		
						125		36,16		
Fall time	$t_f$					150		36,8		ns
Turn-on energy (per pulse)	$E_{on}$	$Q_{fFWD}=2,03 \mu\text{C}$ $Q_{rFWD}=4,81 \mu\text{C}$ $Q_{tFWD}=5,98 \mu\text{C}$				25		177,28		
						125		211,52		
Turn-off energy (per pulse)	$E_{off}$					150		220,48		
						25		23,48		
						125		42,87		
						150		49,36		ns
						25		13,03		
						125		13,86		mWs
						150		14,12		
						25		9,81		
						125		15,27		mWs
						150		17,09		



**B0-SL10NIB600S702-PA29F78Z**  
**B0-SL10NIC600S702-PA39F78Z**

Vincotech

datasheet

## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$I_D$ [A]	$T_j$ [°C]	Min	Typ	Max

### Buck Diode

#### Static

Forward voltage	$V_F$				160	25 125 150		1,72 2,17 2,32	1,8 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_F = 1200$ V			25		280	1600	$\mu$ A	

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 4,4$ W/mK (PTM)						0,22		K/W
--	---------------	---------------------------------------	--	--	--	--	--	------	--	-----

#### Dynamic

Peak recovery current	$I_{RRM}$	$di/dt=7077$ A/ $\mu$ s $di/dt=7276$ A/ $\mu$ s $di/dt=7141$ A/ $\mu$ s	$\pm 15$	600	355	25		70,95		
Reverse recovery time	$t_{rr}$					125		132,07		
Recovered charge	$Q_r$					150		130,46		A
Recovered charge	$Q_r$		$\pm 15$	600	355	25		48,1		
Reverse recovered energy	$E_{rec}$					125		83,38		ns
Reverse recovered energy	$E_{rec}$					150		82,72		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		$\pm 15$	600	355	25		2,03		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					125		4,81		$\mu$ C
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					150		5,98		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		$\pm 15$	600	355	25		0,588		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					125		1,77		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					150		2,31		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		$\pm 15$	600	355	25		9934		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					125		8057		$A/\mu$ s
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					150		1496		



Vincotech

**B0-SL10NIB600S702-PA29F78Z  
B0-SL10NIC600S702-PA39F78Z**

datasheet

## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$I_D$ [A]	$T_j$ [°C]	Min	Typ	Max

### Buck Sw. Protection Diode

#### Static

Forward voltage	$V_F$				100	25 125 150	2,1	2,64 2,44 2,36	2,8 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_r = 950$ V			25				4	µA

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 4,4$ W/mK (PTM)						0,59		K/W
--	---------------	---------------------------------------	--	--	--	--	--	------	--	-----



## Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max		

### Boost Switch

#### Static

Gate-emitter threshold voltage	$V_{GE(\text{th})}$			10	0,06	25	5,4	6	6,6	V
Collector-emitter saturation voltage	$V_{CE(\text{sat})}$		15		600	25 125 150		1,69 1,88 1,93	1,85 <sup>(1)</sup>	V
Collector-emitter cut-off current	$I_{CES}$		0	1200		25			300	μA
Gate-emitter leakage current	$I_{GES}$		20	0		25			1500	nA
Internal gate resistance	$r_g$						0,667			Ω
Input capacitance	$C_{res}$		0	10	25		111000			pF
Output capacitance	$C_{oes}$						3300			pF
Reverse transfer capacitance	$C_{res}$						1260			pF
Gate charge	$Q_g$	$V_{CC} = 600 \text{ V}$	15		600	25		3600		nC

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{\text{paste}} = 4,4 \text{ W/mK}$ (PTM)						0,1		K/W
--	---------------	--	--	--	--	--	--	-----	--	-----

#### Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 2 \Omega$ $R_{goff} = 2 \Omega$	$\pm 15$	600	600	25		575,36		
Rise time	$t_r$					125		579,52		
						150		580,48		
Turn-off delay time	$t_{d(off)}$					25		162,56		
Fall time	$t_f$					125		180,16		
						150		185,6		
Turn-on energy (per pulse)	$E_{on}$	$Q_{fFWD}=6,82 \mu\text{C}$ $Q_{rFWD}=16,32 \mu\text{C}$ $Q_{tFWD}=20,12 \mu\text{C}$				25		352		
Turn-off energy (per pulse)	$E_{off}$					125		380,16		
						150		390,4		
						25		74,94		
						125		90,78		
						150		96,85		
						25		78,74		
						125		96,71		
						150		102,89		mWs
						25		48,08		
						125		61,68		
						150		66,49		mWs



Vincotech

**B0-SL10NIB600S702-PA29F78Z  
B0-SL10NIC600S702-PA39F78Z**

datasheet

## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		$V_{GE}$ [V] $V_{GS}$ [V]	$V_{CE}$ [V] $V_{DS}$ [V] $V_F$ [V]	$I_C$ [A] $I_D$ [A] $I_F$ [A]	$T_j$ [°C]	Min	Typ	Max			

### Boost Diode

#### Static

Forward voltage	$V_F$				300	25 125 150	2,1	2,59 2,43 2,37	2,8 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_F = 950$ V			25			12	μA	

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 4,4$ W/mK (PTM)						0,23		K/W
--	---------------	---------------------------------------	--	--	--	--	--	------	--	-----

#### Dynamic

Peak recovery current	$I_{RRM}$	$di/dt=2803$ A/μs $di/dt=2465$ A/μs $di/dt=2448$ A/μs	$\pm 15$	600	600	25		78,34		A
Reverse recovery time	$t_{rr}$					125		111,34		
Recovered charge	$Q_r$					150		121,21		
Recovered charge	$Q_r$		$\pm 15$	600	600	25		186,19		ns
Reverse recovered energy	$E_{rec}$					125		260,94		
Reverse recovered energy	$E_{rec}$					150		295,56		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		$\pm 15$	600	600	25		6,82		$\mu C$
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					125		16,32		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					150		20,12		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		$\pm 15$	600	600	25		1,6		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					125		4,01		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					150		5,06		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		$\pm 15$	600	600	25		1731		A/μs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					125		256,22		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					150		248,52		



**B0-SL10NIB600S702-PA29F78Z**  
**B0-SL10NIC600S702-PA39F78Z**

Vincotech

datasheet

## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$I_D$ [A]	$T_j$ [°C]	Min	Typ	Max

### Boost Sw. Inv. Diode

#### Static

Forward voltage	$V_F$				225	25 125 150	1,45	1,9 1,83 1,8	1,95 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_r = 1200$ V			25				2,28	µA

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 4,4$ W/mK (PTM)						0,24		K/W
--	---------------	---------------------------------------	--	--	--	--	--	------	--	-----

### Boost Sw. Protection Diode

#### Static

Forward voltage	$V_F$				35	25 125 150		2,53 2,67 2,58	2,62 <sup>(1)</sup> 2,62 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_r = 1200$ V				25 150			60 2700	µA

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 4,4$ W/mK (PTM)						0,84		K/W
--	---------------	---------------------------------------	--	--	--	--	--	------	--	-----



Vincotech

**BO-SL10NIB600S702-PA29F78Z**  
**BO-SL10NIC600S702-PA39F78Z**

datasheet

## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$I_D$ [A]	$T_j$ [°C]	Min	Typ	Max

### Boost D. Protection Diode

#### Static

Forward voltage	$V_F$				100	25 125 150	2,1	2,64 2,44 2,36	2,8 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_F = 950$ V			25			4	$\mu$ A	

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 4,4$ W/mK (PTM)						0,59		K/W
--	---------------	---------------------------------------	--	--	--	--	--	------	--	-----

### Capacitor (DC)

#### Static

Capacitance	C	DC bias voltage = 0 V				25		10		nF
Tolerance							-5		5	%
Dissipation factor		$f = 1$ kHz				25		0,1		%

### Thermistor

#### Static

Rated resistance	R					25		22		kΩ
Deviation of $R_{100}$	$A_{R/R}$	$R_{100} = 1484$ Ω				100	-5		5	%
Power dissipation	P							5		mW
Power dissipation constant	d					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. ±1 %						3962		K
B-value	$B_{(25/100)}$	Tol. ±1 %						4000		K
Vincotech Thermistor Reference								I		

<sup>(1)</sup> Value at chip level<sup>(2)</sup> Only valid with pre-applied Vincotech thermal interface material.



Vincotech

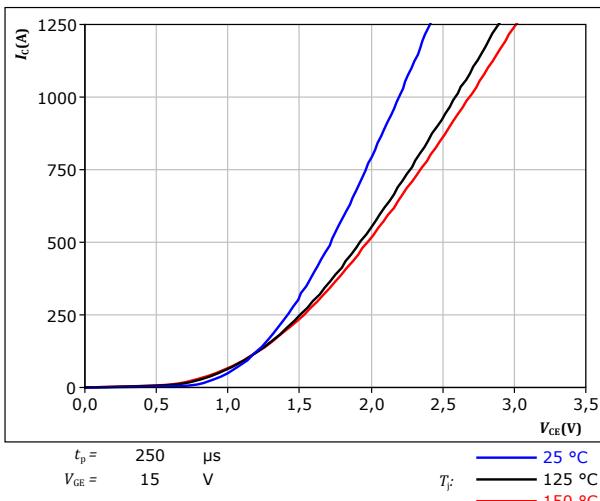
**B0-SL10NIB600S702-PA29F78Z**  
**B0-SL10NIC600S702-PA39F78Z**

datasheet

## Buck Switch Characteristics

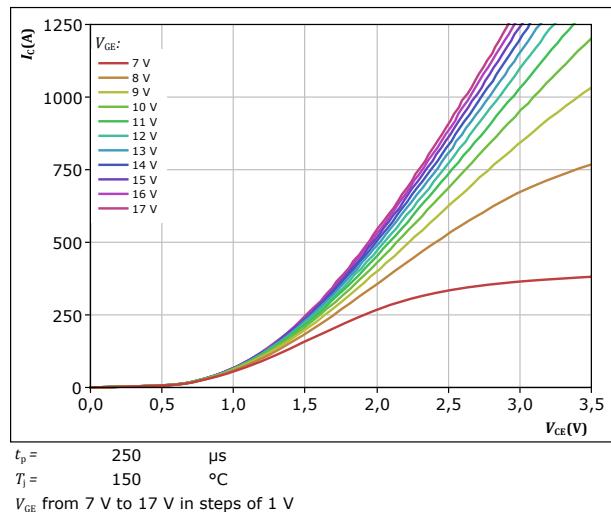
**figure 1.** IGBT

Typical output characteristics  
 $I_C = f(V_{CE})$



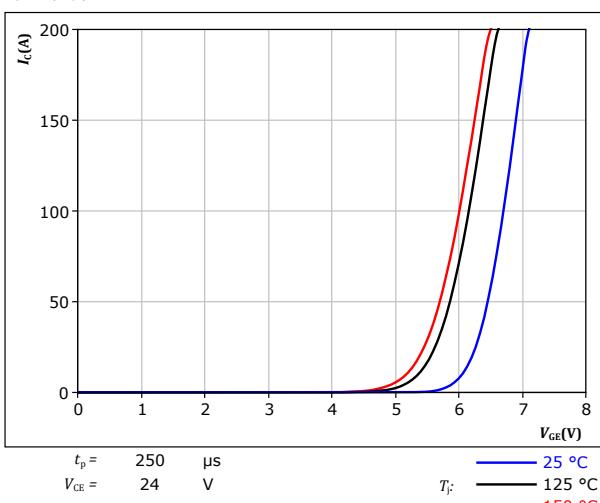
**figure 2.** IGBT

Typical output characteristics  
 $I_C = f(V_{CE})$



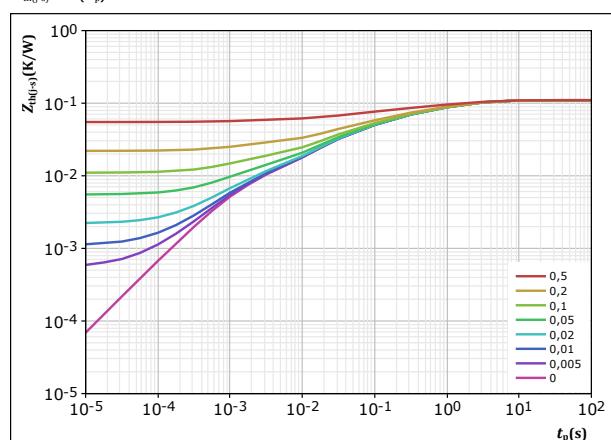
**figure 3.** IGBT

Typical transfer characteristics  
 $I_C = f(V_{GE})$



**figure 4.** IGBT

Transient thermal impedance as a function of pulse width  
 $Z_{th(j-s)} = f(t_p)$



IGBT thermal model values

$R$ (K/W)	$\tau$ (s)
1,72E-02	3,12E+00
2,61E-02	9,92E-01
3,34E-02	1,78E-01
2,60E-02	2,52E-02
7,27E-03	1,28E-03

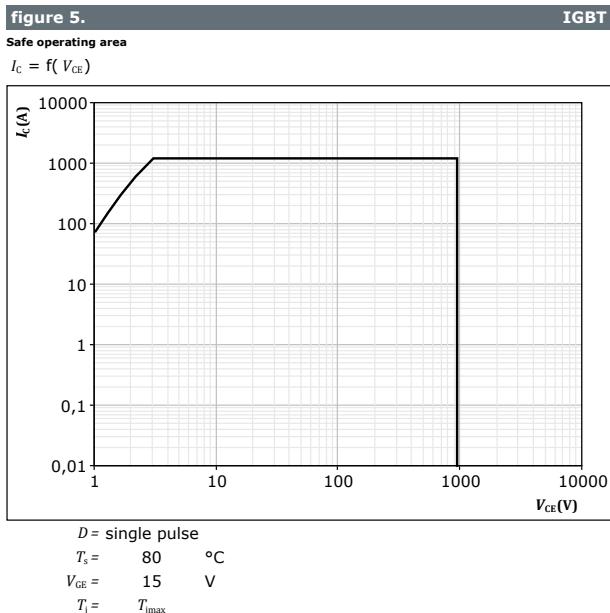


Vincotech

**B0-SL10NIB600S702-PA29F78Z**  
**B0-SL10NIC600S702-PA39F78Z**

datasheet

## Buck Switch Characteristics



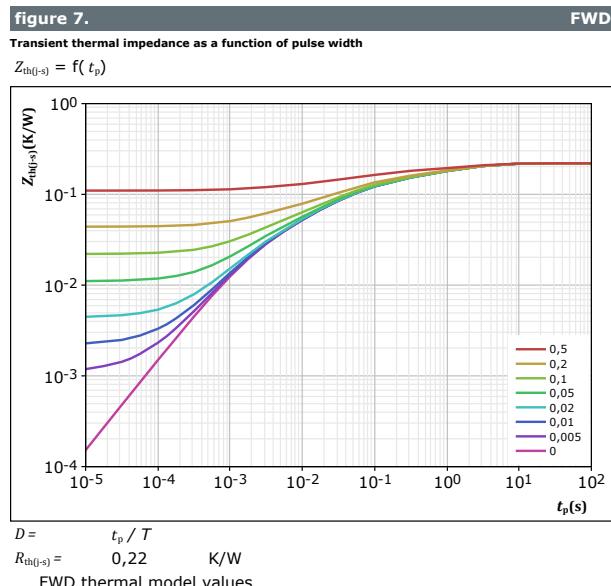
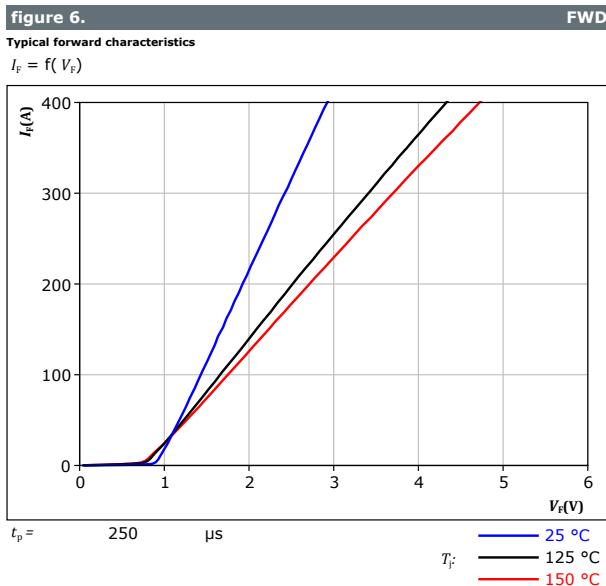


Vincotech

**B0-SL10NIB600S702-PA29F78Z**  
**B0-SL10NIC600S702-PA39F78Z**

datasheet

## Buck Diode Characteristics





Vincotech

**B0-SL10NIB600S702-PA29F78Z  
B0-SL10NIC600S702-PA39F78Z**

datasheet

## Buck Sw. Protection Diode Characteristics

figure 8.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD

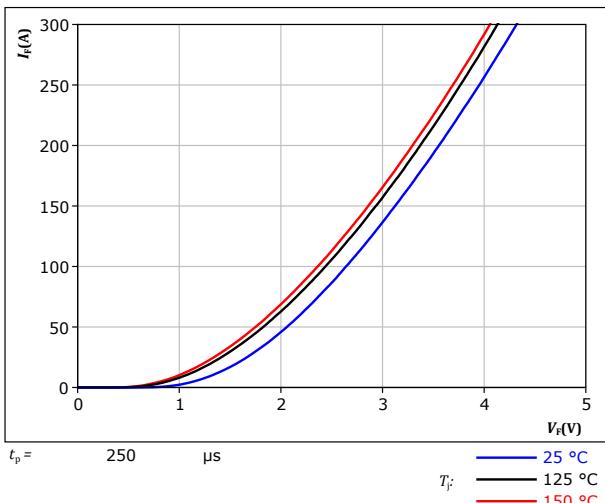
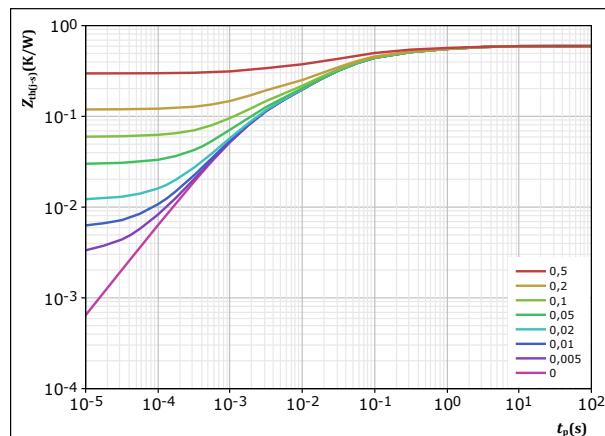


figure 9.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



$$D = \frac{t_p / T}{R_{th(j-s)}} = 0,594 \text{ K/W}$$

FWD thermal model values

$R$ (K/W)	$\tau$ (s)
5,02E-02	2,46E+00
7,95E-02	4,43E-01
2,28E-01	5,90E-02
1,50E-01	1,50E-02
8,75E-02	1,73E-03



Vincotech

**B0-SL10NIB600S702-PA29F78Z  
B0-SL10NIC600S702-PA39F78Z**

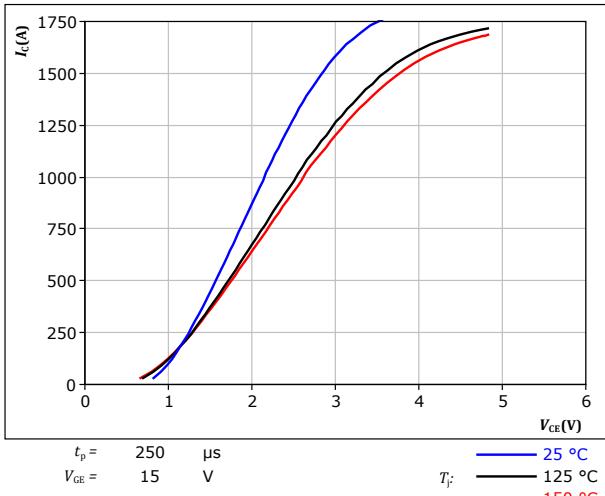
datasheet

## Boost Switch Characteristics

**figure 10.**

Typical output characteristics

$$I_C = f(V_{CE})$$

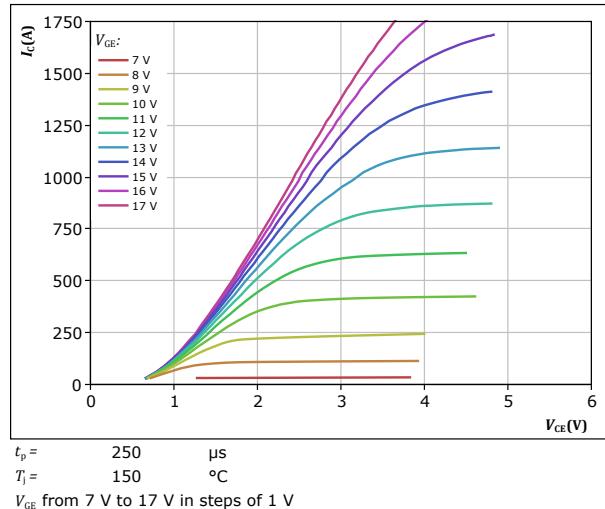


**IGBT**

**figure 11.**

Typical output characteristics

$$I_C = f(V_{CE})$$

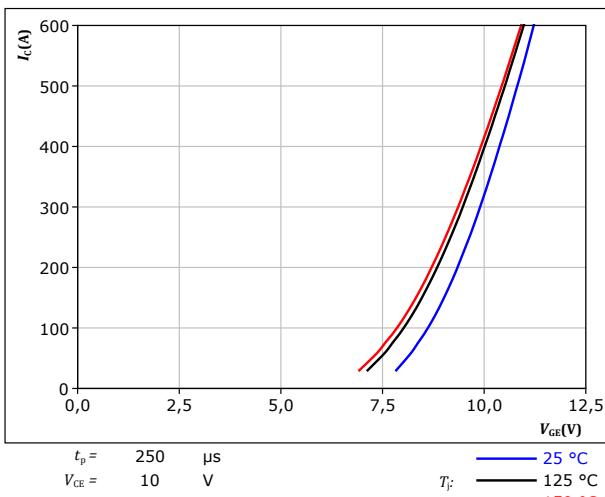


**IGBT**

**figure 12.**

Typical transfer characteristics

$$I_C = f(V_{GE})$$

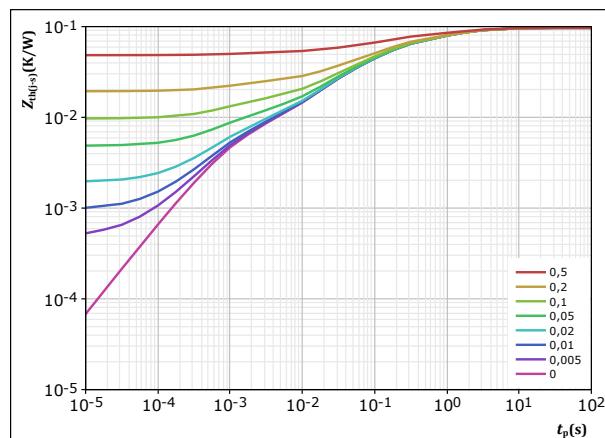


**IGBT**

**figure 13.**

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



**IGBT**

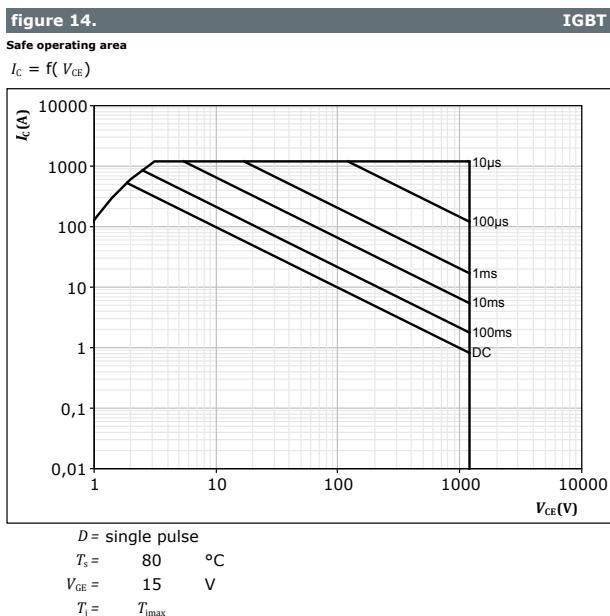


Vincotech

**B0-SL10NIB600S702-PA29F78Z**  
**B0-SL10NIC600S702-PA39F78Z**

datasheet

## Boost Switch Characteristics





Vincotech

**B0-SL10NIB600S702-PA29F78Z**  
**B0-SL10NIC600S702-PA39F78Z**

datasheet

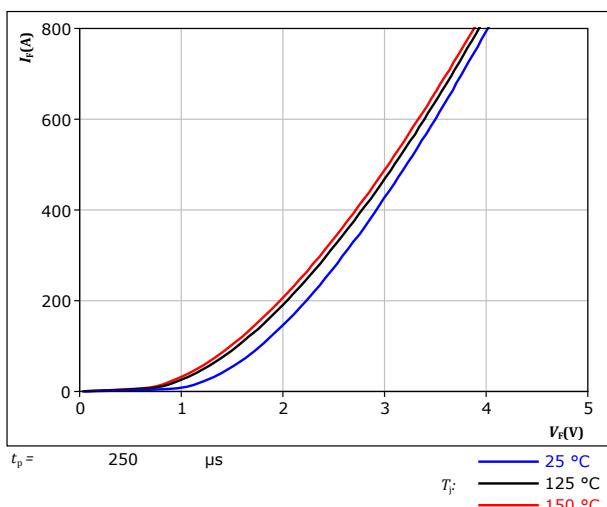
## Boost Diode Characteristics

**figure 15.**

Typical forward characteristics

$$I_F = f(V_F)$$

FWD



$$t_p = 250 \mu\text{s}$$

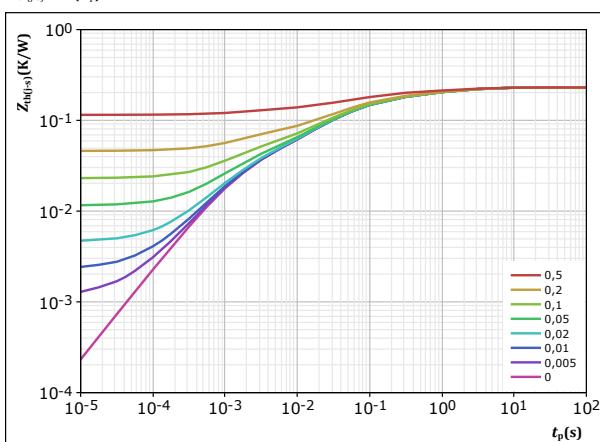
$T_F:$    
 — 25 °C  
 — 125 °C  
 — 150 °C

**figure 16.**

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



$$D = \frac{t_p / T}{R_{th(j-s)}} = 0,23 \quad \text{K/W}$$

FWD thermal model values

$R(K/W)$	$\tau(s)$
2,56E-02	2,90E+00
4,35E-02	5,53E-01
9,09E-02	6,81E-02
4,34E-02	1,43E-02
2,66E-02	1,41E-03



Vincotech

**B0-SL10NIB600S702-PA29F78Z  
B0-SL10NIC600S702-PA39F78Z**

datasheet

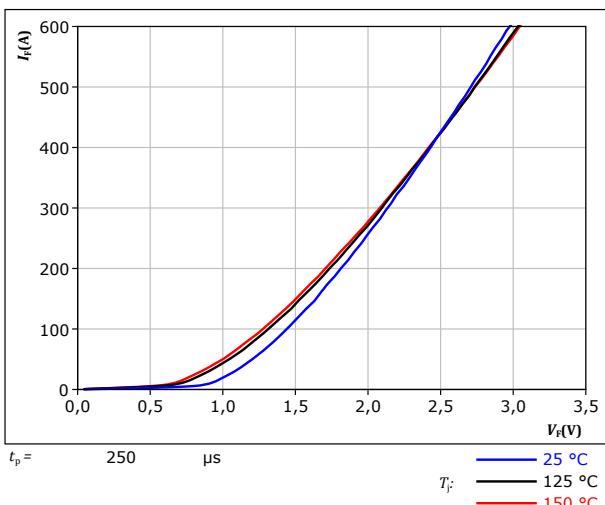
## Boost Sw. Inv. Diode Characteristics

figure 17.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD



$$t_p = 250 \mu\text{s}$$

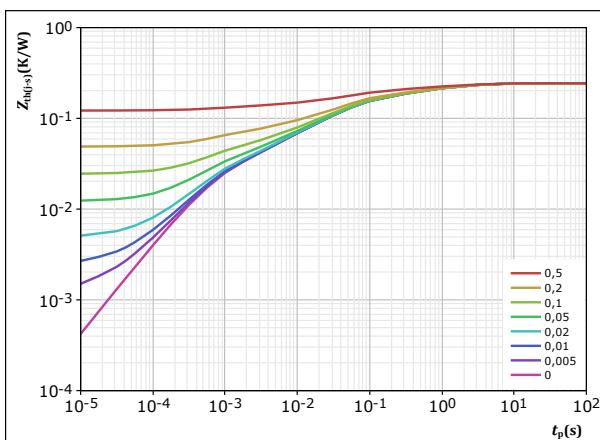
$T_J$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 18.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



$$D = \frac{t_p / T}{R_{th(j-s)}} = 0,244 \text{ K/W}$$

FWD thermal model values

$R$ (K/W)	$\tau$ (s)
3,51E-02	2,48E+00
5,14E-02	4,38E-01
9,82E-02	5,01E-02
3,42E-02	7,68E-03
2,47E-02	6,90E-04



Vincotech

**B0-SL10NIB600S702-PA29F78Z  
B0-SL10NIC600S702-PA39F78Z**

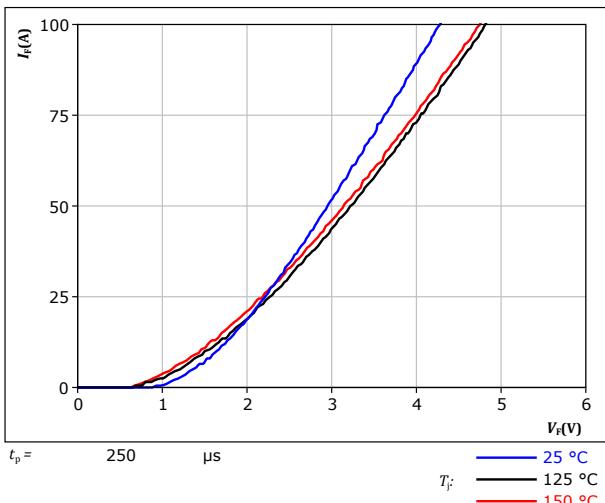
datasheet

## Boost Sw. Protection Diode Characteristics

figure 19.

Typical forward characteristics

$$I_F = f(V_F)$$

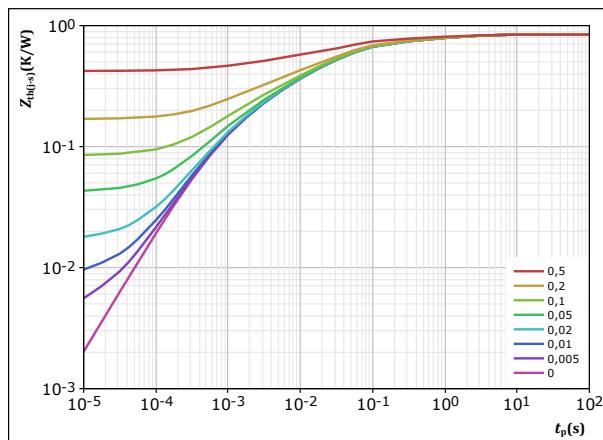


FWD

figure 20.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



FWD

$$D = \frac{t_p}{T}$$

$$R_{th(j-s)} = 0,843 \text{ K/W}$$

FWD thermal model values

$R$ (K/W)	$\tau$ (s)
9,03E-02	1,79E+00
1,29E-01	1,94E-01
3,56E-01	2,98E-02
1,83E-01	3,56E-03
8,48E-02	6,09E-04



Vincotech

**B0-SL10NIB600S702-PA29F78Z  
B0-SL10NIC600S702-PA39F78Z**

datasheet

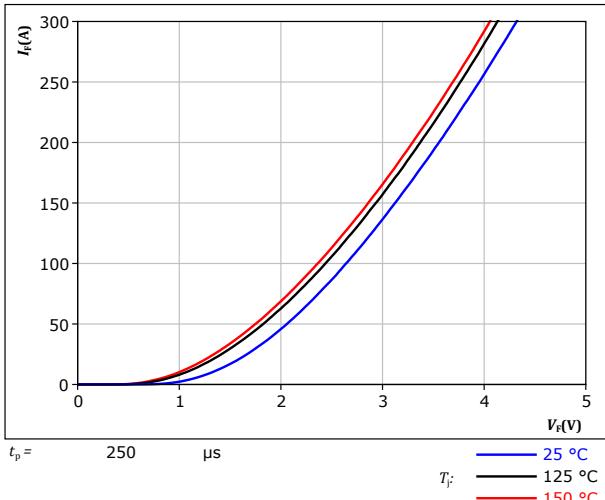
## Boost D. Protection Diode Characteristics

figure 21.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD



$$t_p = 250 \mu\text{s}$$

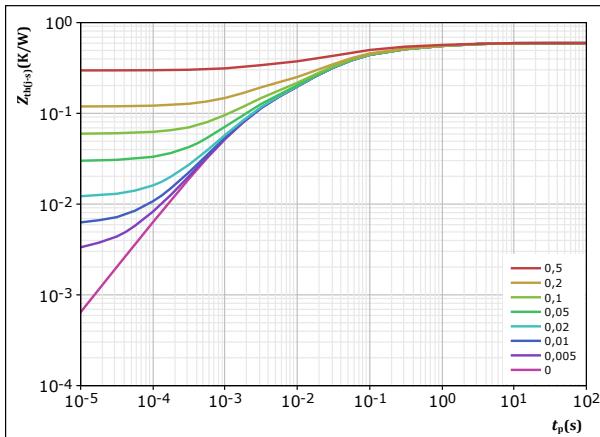
$T_{J_F}$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 22.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



$$D = \frac{t_p / T}{0,594} \quad \text{K/W}$$

FWD thermal model values

$R$ (K/W)	$\tau$ (s)
5,02E-02	2,46E+00
7,95E-02	4,43E-01
2,28E-01	5,90E-02
1,50E-01	1,50E-02
8,75E-02	1,73E-03



Vincotech

**B0-SL10NIB600S702-PA29F78Z  
B0-SL10NIC600S702-PA39F78Z**

datasheet

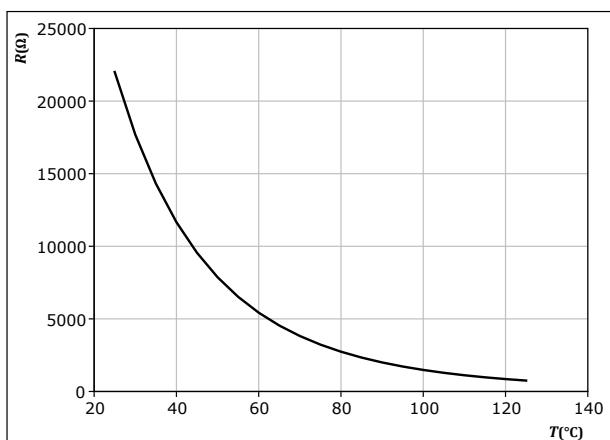
## Thermistor Characteristics

figure 23.

Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$





Vincotech

**B0-SL10NIB600S702-PA29F78Z  
B0-SL10NIC600S702-PA39F78Z**

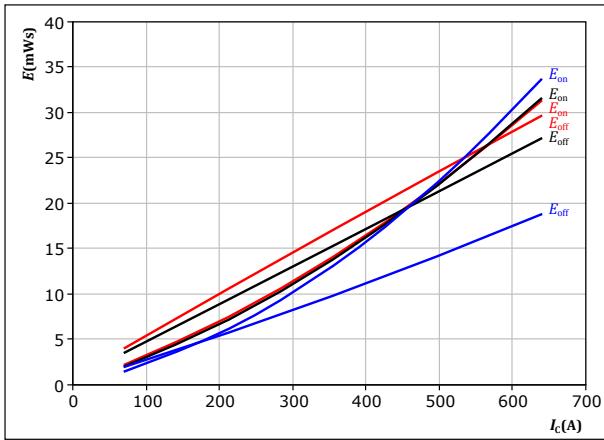
datasheet

## Buck Switching Characteristics

figure 24.

Typical switching energy losses as a function of collector current

$$E = f(I_c)$$



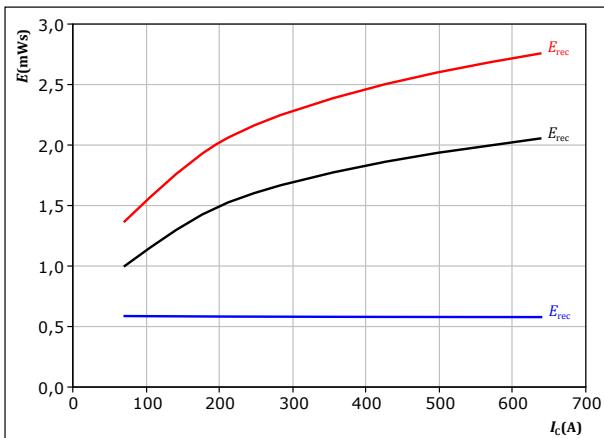
With an inductive load at

$V_{CE} =$	600	V	$T_f:$	25 °C
$V_{GE} =$	±15	V		125 °C
$R_{gon} =$	2	Ω		150 °C
$R_{goff} =$	2	Ω		

figure 26.

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_c)$$



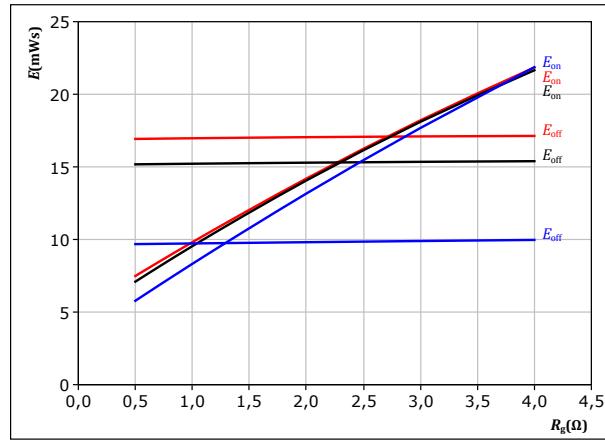
With an inductive load at

$V_{CE} =$	600	V	$T_f:$	25 °C
$V_{GE} =$	±15	V		125 °C
$R_{gon} =$	2	Ω		150 °C

figure 25.

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$



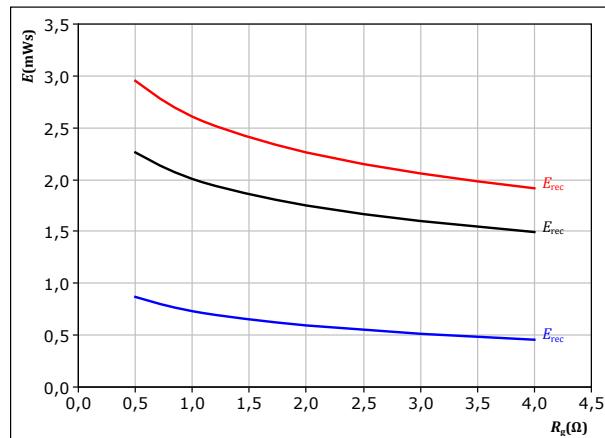
With an inductive load at

$V_{CE} =$	600	V	$T_f:$	25 °C
$V_{GE} =$	±15	V		125 °C
$I_c =$	355	A		150 °C

figure 27.

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{CE} =$	600	V	$T_f:$	25 °C
$V_{GE} =$	±15	V		125 °C
$I_c =$	355	A		150 °C



Vincotech

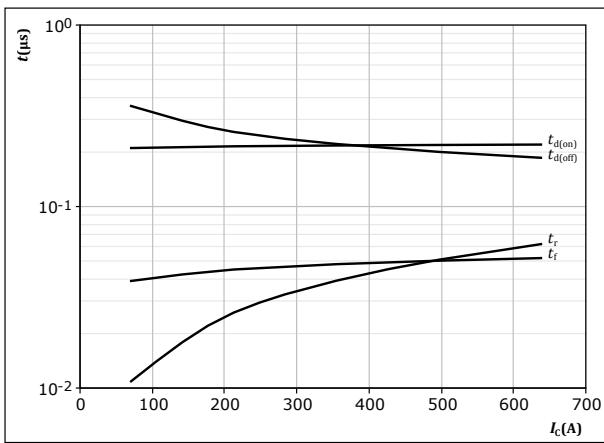
**B0-SL10NIB600S702-PA29F78Z  
B0-SL10NIC600S702-PA39F78Z**

datasheet

## Buck Switching Characteristics

**figure 28.**

Typical switching times as a function of collector current  
 $t = f(I_C)$



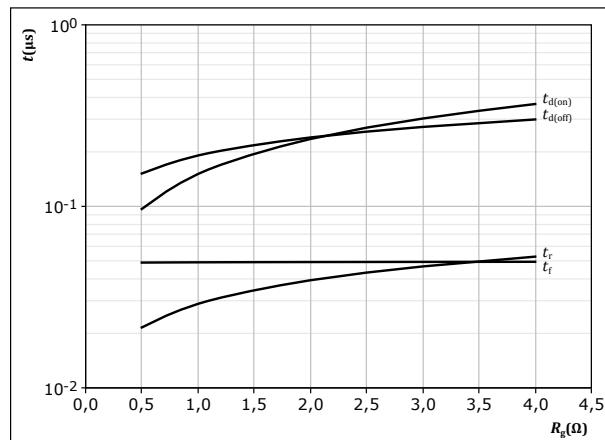
With an inductive load at

$T_j = 150^\circ\text{C}$   
 $V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 2 \Omega$   
 $R_{goff} = 2 \Omega$

**IGBT**

**figure 29.**

Typical switching times as a function of gate resistor  
 $t = f(R_g)$



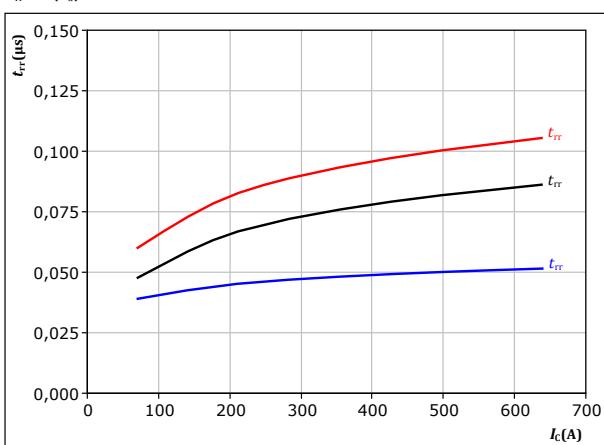
With an inductive load at

$T_j = 150^\circ\text{C}$   
 $V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_C = 355 \text{ A}$

**IGBT**

**figure 30.**

Typical reverse recovery time as a function of collector current  
 $t_{rr} = f(I_C)$



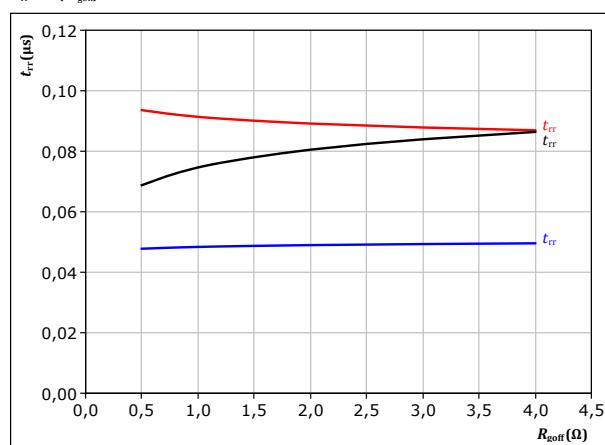
With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 2 \Omega$

**FWD**

**figure 31.**

Typical reverse recovery time as a function of IGBT turn off gate resistor  
 $t_{rr} = f(R_{goff})$



With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_C = 355 \text{ A}$

**FWD**



Vincotech

**B0-SL10NIB600S702-PA29F78Z  
B0-SL10NIC600S702-PA39F78Z**

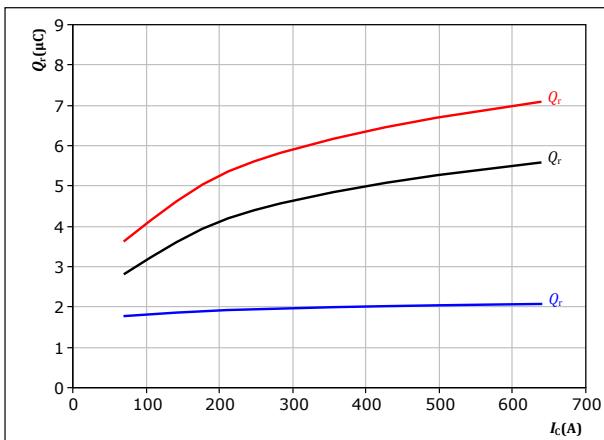
datasheet

## Buck Switching Characteristics

**figure 32.**

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



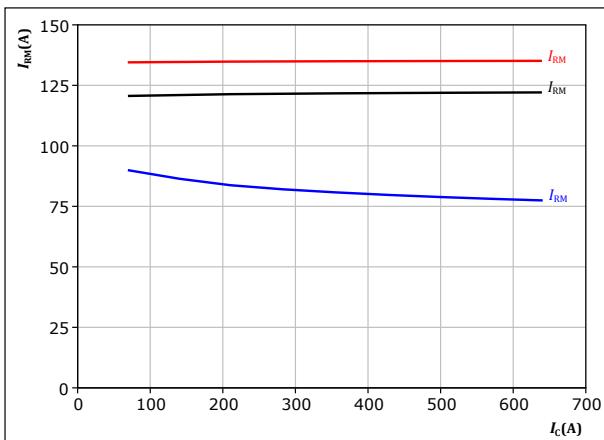
With an inductive load at

$V_{CE} = 600$ V	$T_f:$	25 °C
$V_{GE} = \pm 15$ V		125 °C
$R_{gon} = 2$ Ω		150 °C

**figure 34.**

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



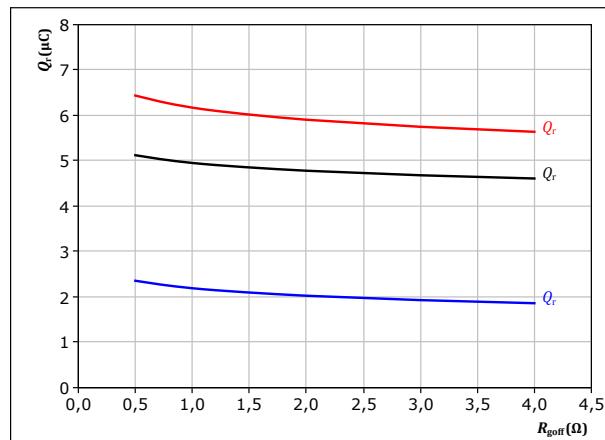
With an inductive load at

$V_{CE} = 600$ V	$T_f:$	25 °C
$V_{GE} = \pm 15$ V		125 °C
$R_{gon} = 2$ Ω		150 °C

**figure 33.**

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{go\bar{f}})$$



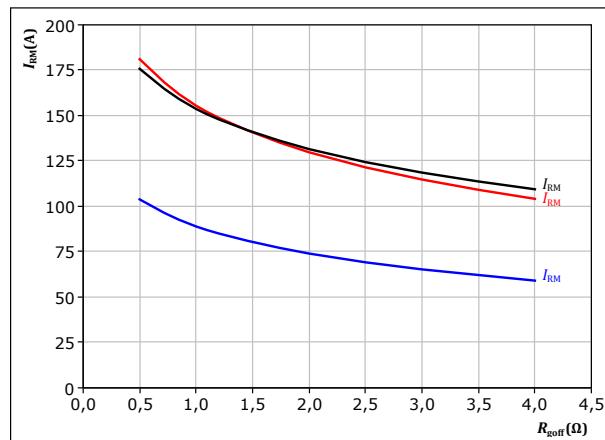
With an inductive load at

$V_{CE} = 600$ V	$T_f:$	25 °C
$V_{GE} = \pm 15$ V		125 °C
$I_c = 355$ A		150 °C

**figure 35.**

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{go\bar{f}})$$



With an inductive load at

$V_{CE} = 600$ V	$T_f:$	25 °C
$V_{GE} = \pm 15$ V		125 °C
$I_c = 355$ A		150 °C



Vincotech

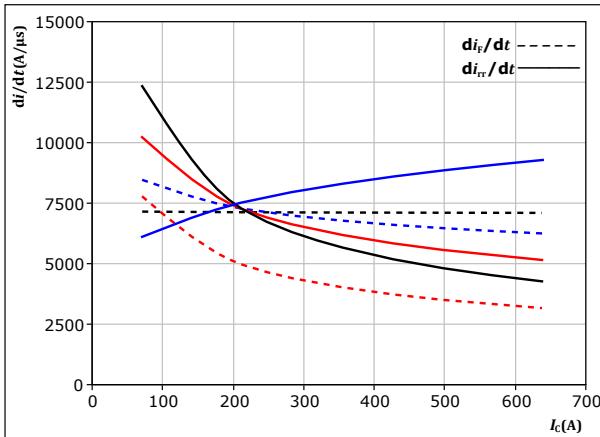
**B0-SL10NIB600S702-PA29F78Z**  
**B0-SL10NIC600S702-PA39F78Z**

datasheet

## Buck Switching Characteristics

**figure 36.** FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current  
 $di_f/dt, di_{rr}/dt = f(I_c)$

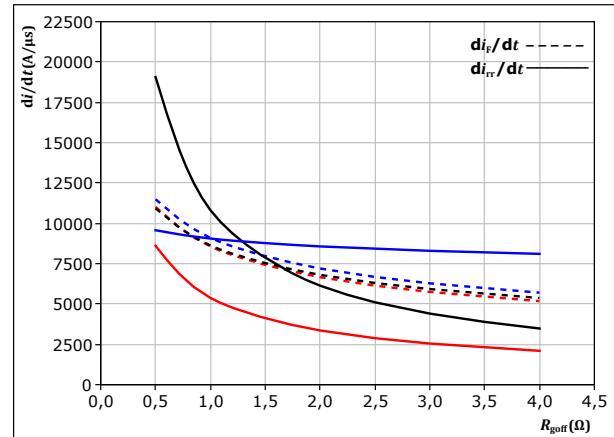


With an inductive load at

$V_{CE} = 600 \text{ V}$	$T_j = 25^\circ\text{C}$
$V_{GE} = \pm 15 \text{ V}$	$T_j = 125^\circ\text{C}$
$R_{gon} = 2 \Omega$	$T_j = 150^\circ\text{C}$

**figure 37.** FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor  
 $di_f/dt, di_{rr}/dt = f(R_{goff})$



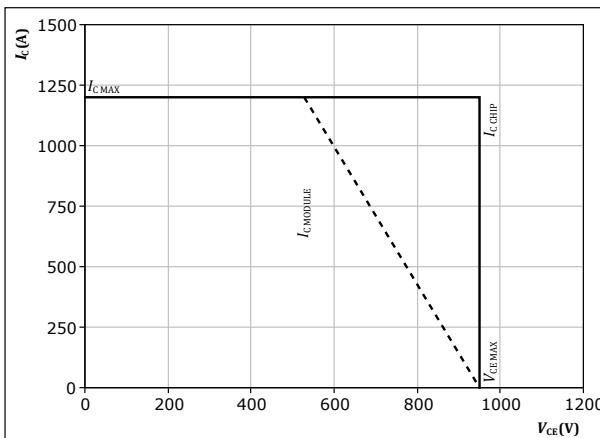
With an inductive load at

$V_{CE} = 600 \text{ V}$	$T_j = 25^\circ\text{C}$
$V_{GE} = \pm 15 \text{ V}$	$T_j = 125^\circ\text{C}$
$I_c = 355 \text{ A}$	$T_j = 150^\circ\text{C}$

**figure 38.** IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



At  $T_j = 150^\circ\text{C}$   
 $R_{gon} = 2 \Omega$   
 $R_{goff} = 2 \Omega$



Vincotech

**BO-SL10NIB600S702-PA29F78Z**  
**BO-SL10NIC600S702-PA39F78Z**

datasheet

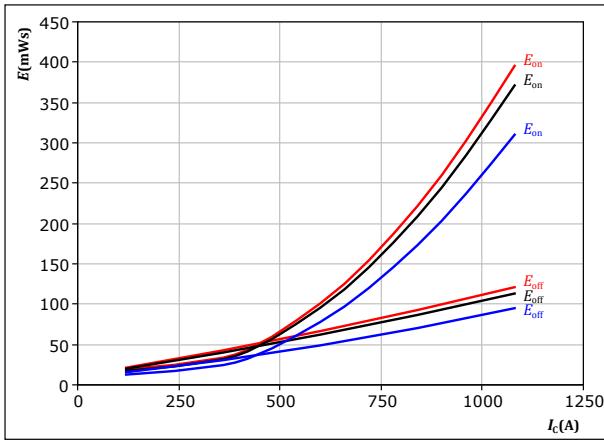
## Boost Switching Characteristics

figure 39.

IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_c)$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 600 \text{ V} \\ V_{GE} &= \pm 15 \text{ V} \\ R_{gon} &= 2 \Omega \\ R_{goff} &= 2 \Omega \end{aligned}$$

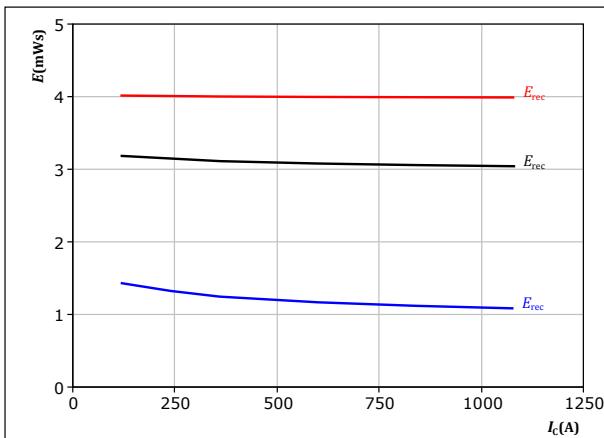
$$\begin{aligned} T_f: & 25^\circ\text{C} \\ & 125^\circ\text{C} \\ & 150^\circ\text{C} \end{aligned}$$

figure 41.

FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_c)$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 600 \text{ V} \\ V_{GE} &= \pm 15 \text{ V} \\ R_{gon} &= 2 \Omega \end{aligned}$$

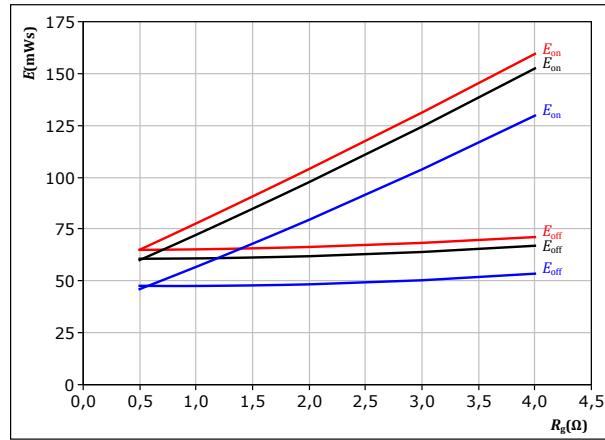
$$\begin{aligned} T_f: & 25^\circ\text{C} \\ & 125^\circ\text{C} \\ & 150^\circ\text{C} \end{aligned}$$

figure 40.

IGBT

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 600 \text{ V} \\ V_{GE} &= \pm 15 \text{ V} \\ I_c &= 600 \text{ A} \end{aligned}$$

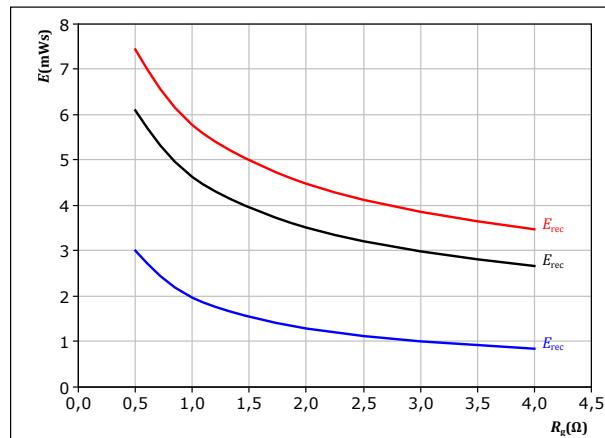
$$\begin{aligned} T_f: & 25^\circ\text{C} \\ & 125^\circ\text{C} \\ & 150^\circ\text{C} \end{aligned}$$

figure 42.

FWD

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 600 \text{ V} \\ V_{GE} &= \pm 15 \text{ V} \\ I_c &= 600 \text{ A} \end{aligned}$$

$$\begin{aligned} T_f: & 25^\circ\text{C} \\ & 125^\circ\text{C} \\ & 150^\circ\text{C} \end{aligned}$$



Vincotech

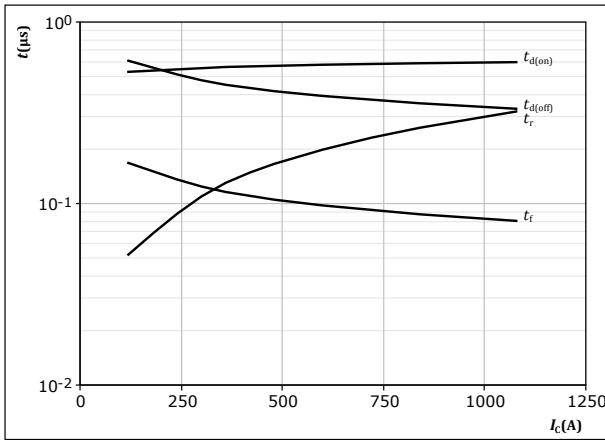
**B0-SL10NIB600S702-PA29F78Z  
B0-SL10NIC600S702-PA39F78Z**

datasheet

## Boost Switching Characteristics

**figure 43.**

Typical switching times as a function of collector current  
 $t = f(I_C)$



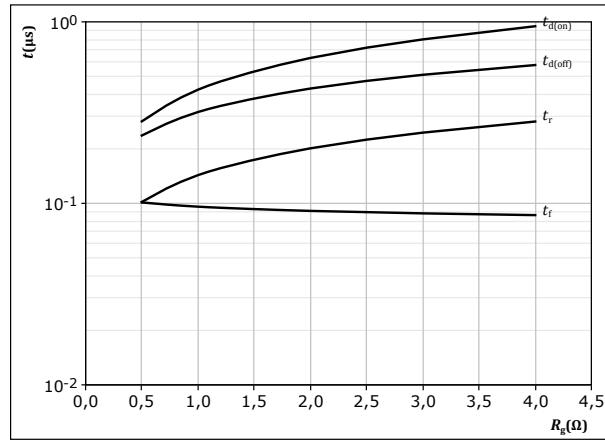
With an inductive load at

$T_j = 150^\circ\text{C}$   
 $V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 2 \Omega$   
 $R_{goff} = 2 \Omega$

**IGBT**

**figure 44.**

Typical switching times as a function of gate resistor  
 $t = f(R_g)$



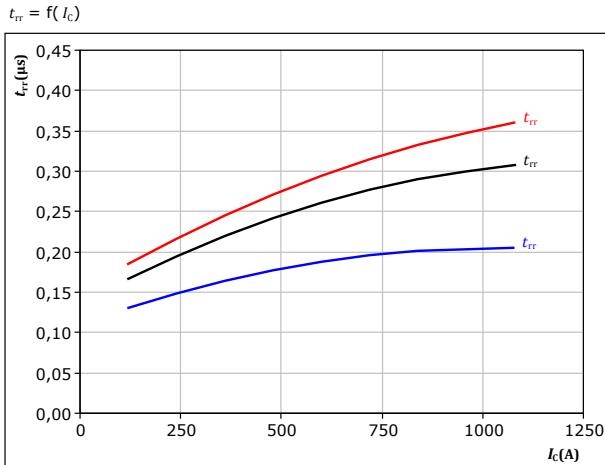
With an inductive load at

$T_j = 150^\circ\text{C}$   
 $V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_C = 600 \text{ A}$

**IGBT**

**figure 45.**

Typical reverse recovery time as a function of collector current  
 $t_{rr} = f(I_C)$



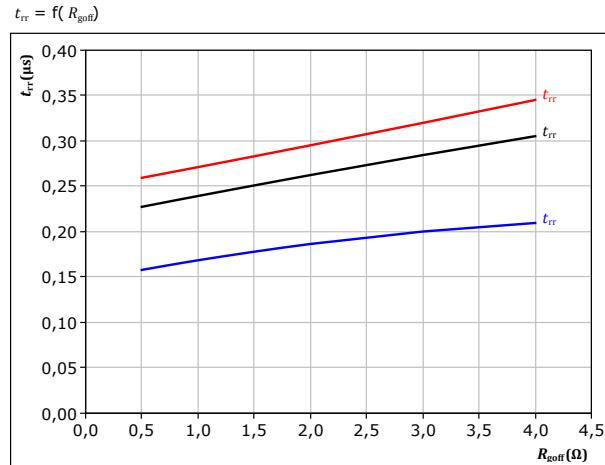
With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 2 \Omega$

**FWD**

**figure 46.**

Typical reverse recovery time as a function of IGBT turn off gate resistor  
 $t_{rr} = f(R_{goff})$



With an inductive load at

$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_C = 600 \text{ A}$

**FWD**



Vincotech

**B0-SL10NIB600S702-PA29F78Z**  
**B0-SL10NIC600S702-PA39F78Z**

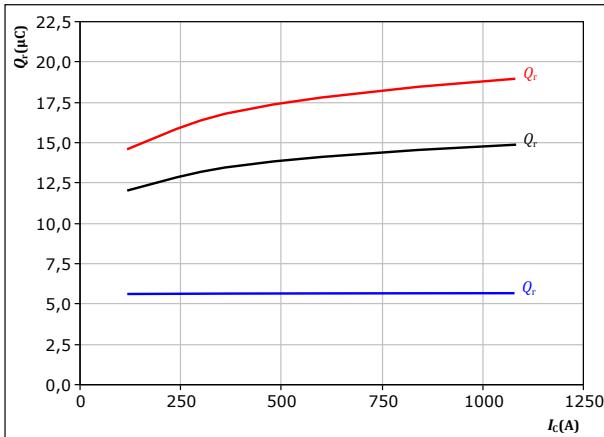
datasheet

## Boost Switching Characteristics

figure 47.

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

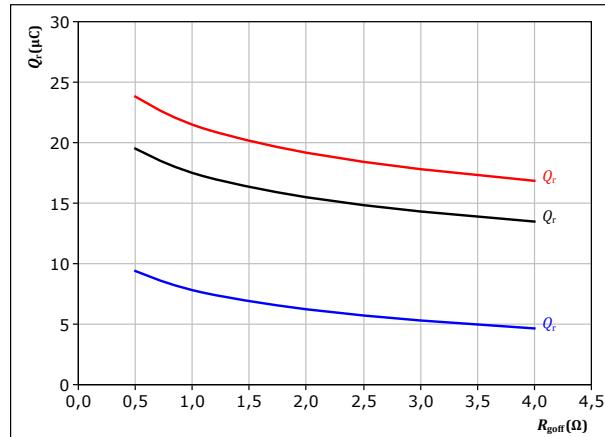
$V_{CE} = 600$ V	$T_f = 25$ °C
$V_{GE} = \pm 15$ V	$T_f = 125$ °C
$R_{gon} = 2$ Ω	$T_f = 150$ °C

FWD

figure 48.

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{go\bar{f}})$$



With an inductive load at

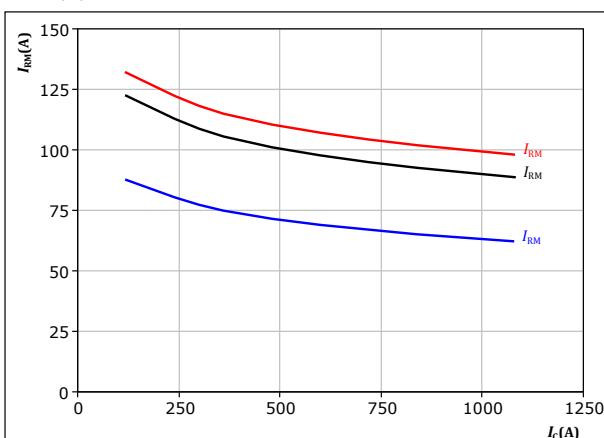
$V_{CE} = 600$ V	$T_f = 25$ °C
$V_{GE} = \pm 15$ V	$T_f = 125$ °C
$I_c = 600$ A	$T_f = 150$ °C

FWD

figure 49.

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

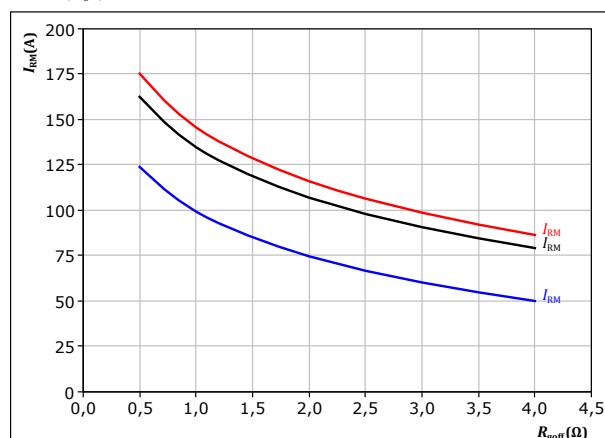
$V_{CE} = 600$ V	$T_f = 25$ °C
$V_{GE} = \pm 15$ V	$T_f = 125$ °C
$R_{gon} = 2$ Ω	$T_f = 150$ °C

FWD

figure 50.

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{go\bar{f}})$$



With an inductive load at

$V_{CE} = 600$ V	$T_f = 25$ °C
$V_{GE} = \pm 15$ V	$T_f = 125$ °C
$I_c = 600$ A	$T_f = 150$ °C

FWD



Vincotech

**B0-SL10NIB600S702-PA29F78Z  
B0-SL10NIC600S702-PA39F78Z**

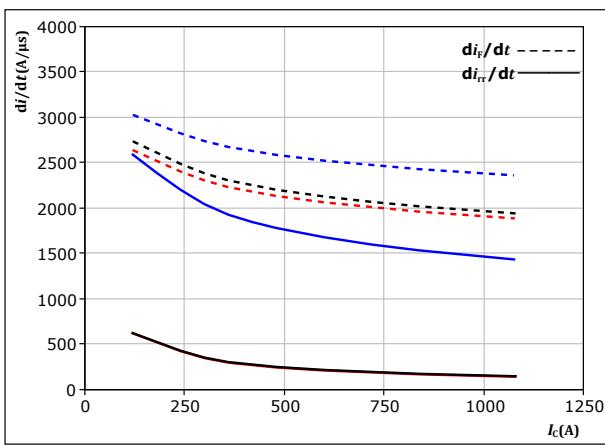
datasheet

## Boost Switching Characteristics

**figure 51.** FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current

$di_f/dt, di_{rr}/dt = f(I_c)$



With an inductive load at

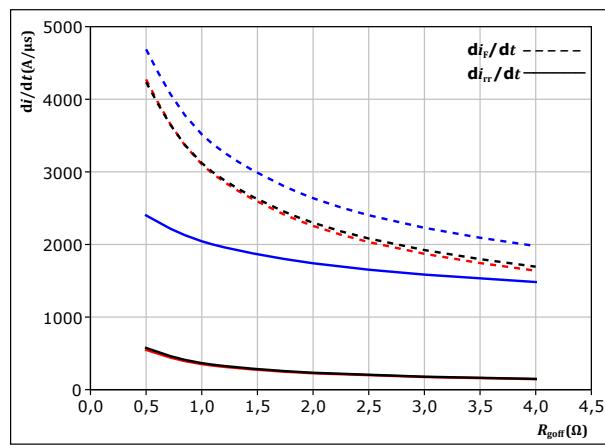
$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $R_{gon} = 2 \Omega$

$T_j:$  — 25 °C  
— 125 °C  
— 150 °C

**figure 52.** FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor

$di_f/dt, di_{rr}/dt = f(R_{goff})$



With an inductive load at

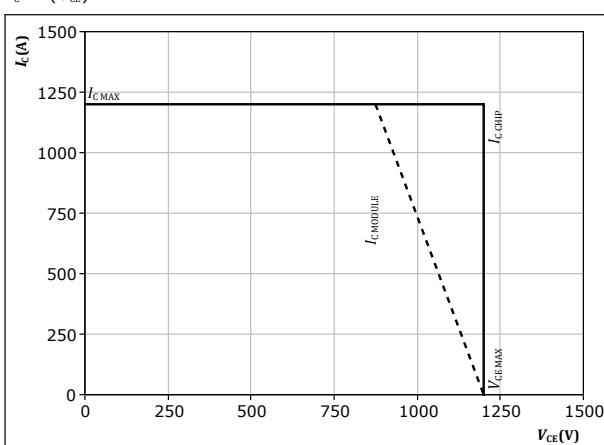
$V_{CE} = 600 \text{ V}$   
 $V_{GE} = \pm 15 \text{ V}$   
 $I_c = 600 \text{ A}$

$T_j:$  — 25 °C  
— 125 °C  
— 150 °C

**figure 53.** IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



At  $T_j = 150 \text{ }^\circ\text{C}$   
 $R_{gon} = 2 \Omega$   
 $R_{goff} = 2 \Omega$



Vincotech

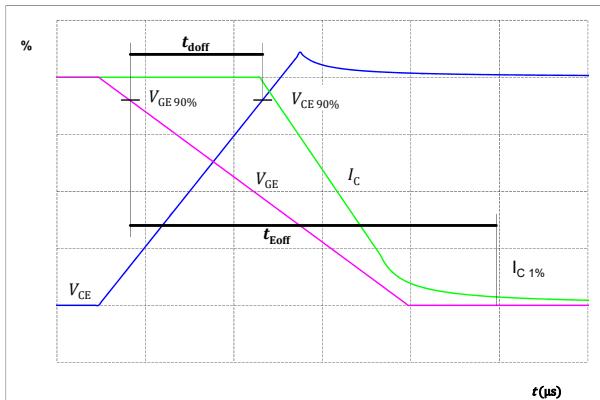
**B0-SL10NIB600S702-PA29F78Z  
B0-SL10NIC600S702-PA39F78Z**

datasheet

## Switching Definitions

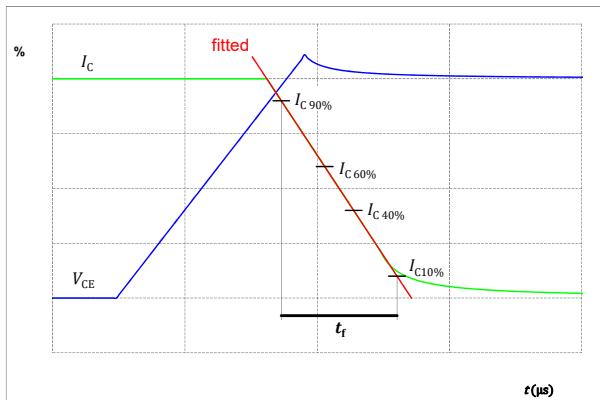
**figure 54.** IGBT

Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$  ( $t_{Eoff}$  = integrating time for  $E_{off}$ )



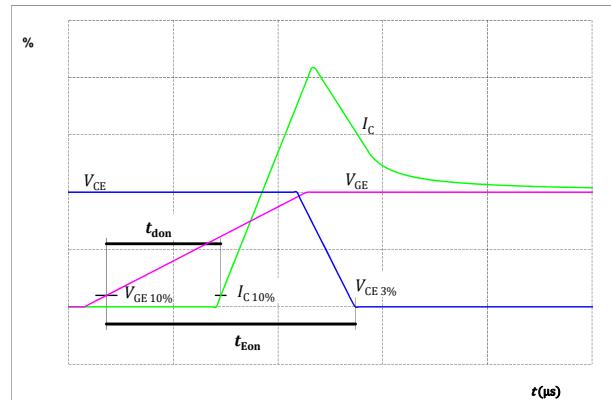
**figure 56.** IGBT

Turn-off Switching Waveforms & definition of  $t_f$



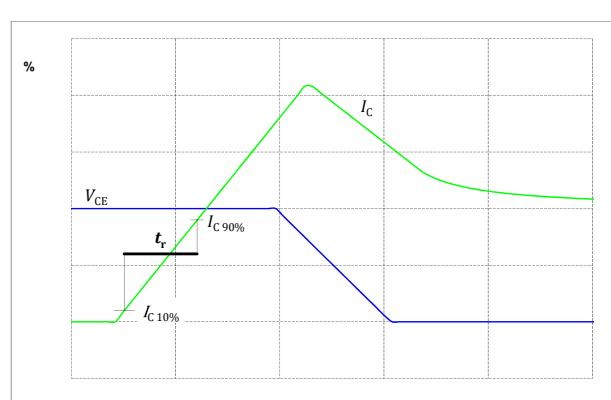
**figure 55.** IGBT

Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$  ( $t_{Eon}$  = integrating time for  $E_{on}$ )



**figure 57.** IGBT

Turn-on Switching Waveforms & definition of  $t_r$





Vincotech

**B0-SL10NIB600S702-PA29F78Z**  
**B0-SL10NIC600S702-PA39F78Z**

datasheet

## Switching Definitions

figure 58.

Turn-off Switching Waveforms & definition of  $t_{tr}$

FWD

Copyright Vincotech

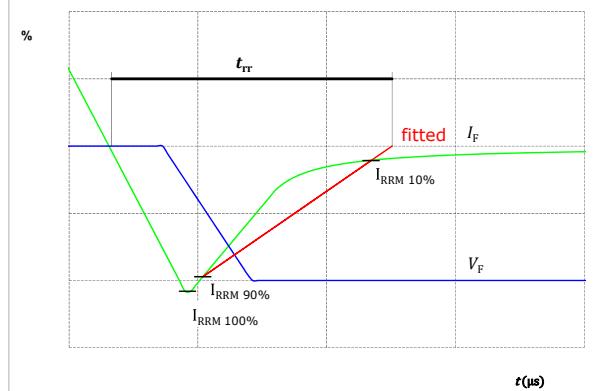
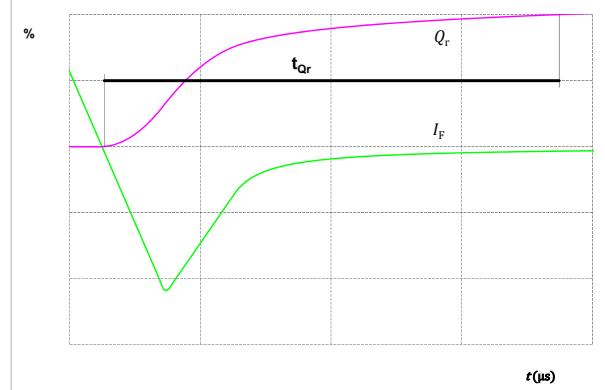


figure 59.

Turn-on Switching Waveforms & definition of  $t_{qr}$  ( $t_{qr}$  = integrating time for  $Q_r$ )

FWD

Copyright Vincotech

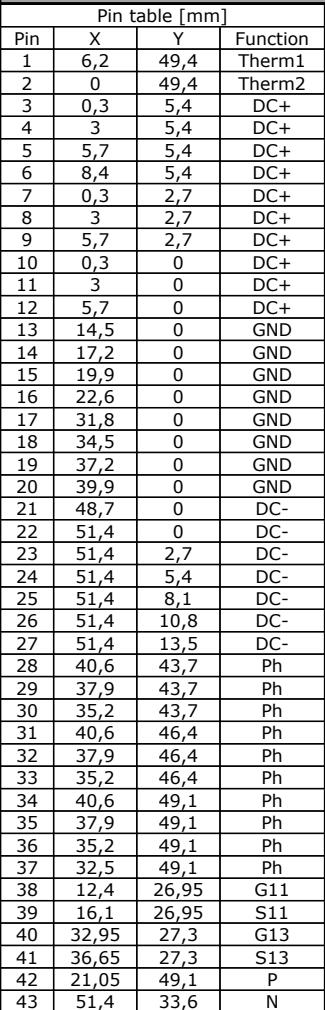




Vincotech

**B0-SL10NIB600S702-PA29F78Z**  
**B0-SL10NIC600S702-PA39F78Z**

datasheet

Ordering Code						
Version		Ordering Code				
With thermal paste (4,4 W/mK, PTM6000)		B0-SL10NIB600S702-PA29F78Z-/7/				
Marking						
NN-NNNNNNNNNNNNNN TTTTTTVVWWYY UL VIN LLLLLL SSSS	Text	Name NN-NNNNNNNNNNNNNN- TTTTTTVV	Date code WWYY	UL & VIN UL VIN	Lot LLLLL	Serial SSSS
	Datamatrix	Type&Ver TTTTTTVV	Lot number LLLLL	Serial SSSS	Date code WWYY	
High Side Module B0-SL10NIB600S702-PA29F78Z						
Outline						
Pin table [mm]						
Pin	X	Y	Function			
1	6,2	49,4	Therm1			
2	0	49,4	Therm2			
3	0,3	5,4	DC+			
4	3	5,4	DC+			
5	5,7	5,4	DC+			
6	8,4	5,4	DC+			
7	0,3	2,7	DC+			
8	3	2,7	DC+			
9	5,7	2,7	DC+			
10	0,3	0	DC+			
11	3	0	DC+			
12	5,7	0	DC+			
13	14,5	0	GND			
14	17,2	0	GND			
15	19,9	0	GND			
16	22,6	0	GND			
17	31,8	0	GND			
18	34,5	0	GND			
19	37,2	0	GND			
20	39,9	0	GND			
21	48,7	0	DC-			
22	51,4	0	DC-			
23	51,4	2,7	DC-			
24	51,4	5,4	DC-			
25	51,4	8,1	DC-			
26	51,4	10,8	DC-			
27	51,4	13,5	DC-			
28	40,6	43,7	Ph			
29	37,9	43,7	Ph			
30	35,2	43,7	Ph			
31	40,6	46,4	Ph			
32	37,9	46,4	Ph			
33	35,2	46,4	Ph			
34	40,6	49,1	Ph			
35	37,9	49,1	Ph			
36	35,2	49,1	Ph			
37	32,5	49,1	Ph			
38	12,4	26,95	G11			
39	16,1	26,95	S11			
40	32,95	27,3	G13			
41	36,65	27,3	S13			
42	21,05	49,1	P			
43	51,4	33,6	N			



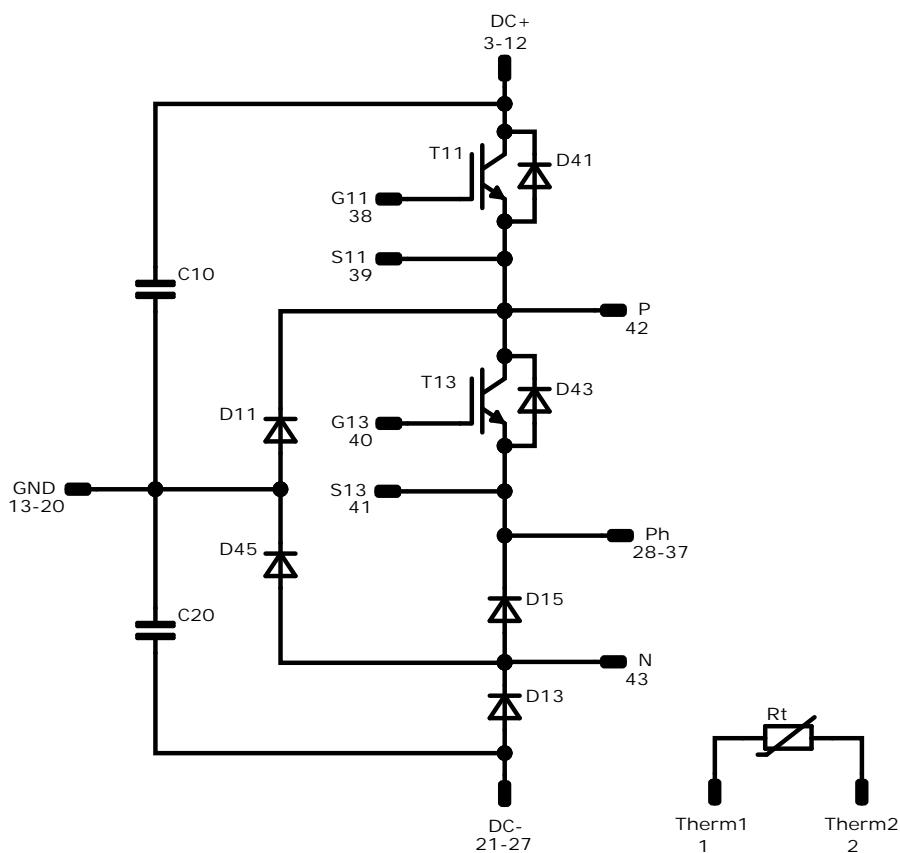
**B0-SL10NIB600S702-PA29F78Z**  
**B0-SL10NIC600S702-PA39F78Z**

Vincotech

datasheet

## High Side Module B0-SL10NIB600S702-PA29F78Z

### Pinout



### Identification

ID	Component	Voltage	Current	Function	Comment
T11	IGBT	950 V	600 A	Buck Switch	
D11	FWD	1200 V	160 A	Buck Diode	
D41	FWD	950 V	100 A	Buck Sw. Protection Diode	
T13	IGBT	1200 V	600 A	Boost Switch	
D13	FWD	950 V	300 A	Boost Diode	
D15	FWD	1200 V	225 A	Boost Sw. Inv. Diode	
D43	FWD	1200 V	35 A	Boost Sw. Protection Diode	
D45	FWD	950 V	100 A	Boost D. Protection Diode	
C10, C20	Capacitor	1000 V		Capacitor (DC)	
Rt	Thermistor			Thermistor	



Vincotech

**B0-SL10NIB600S702-PA29F78Z**  
**B0-SL10NIC600S702-PA39F78Z**

datasheet

Ordering Code	
Version	Ordering Code
With thermal paste (4,4 W/mK, PTM6000)	B0-SL10NIC600S702-PA39F78Z-/7/

Marking						
Text	Name		Date code	UL & VIN	Lot	Serial
	NN-NNNNNNNNNNNNNN	WWYY	UL VIN	LLLLL	SSSS	
Datamatrix	Type&Ver TTTTTTVV	Lot number LLLLL	Serial SSSS	Date code WWYY		

### Low Side Module B0-SL10NIC600S702-PA39F78Z

Pin table [mm]				Outline
Pin	X	Y	Function	
1	51,45	49,45	Therm1	
2	46	49,45	Therm2	
3	21,8	49,1	Ph	
4	19,1	49,1	Ph	
5	16,4	49,1	Ph	
6	13,7	49,1	Ph	
7	11	49,1	Ph	
8	21,8	46,4	Ph	
9	19,1	46,4	Ph	
10	16,4	46,4	Ph	
11	13,7	46,4	Ph	
12	11	46,4	Ph	
13	0	25	DC+	
14	0	22,3	DC+	
15	0	19,6	DC+	
16	0	16,9	DC+	
17	0	14,2	DC+	
18	0	11,5	DC+	
19	0	8,8	DC+	
20	0	0	GND	
21	2,6	0	GND	
22	5,2	0	GND	
23	7,8	0	GND	
24	39	0	GND	
25	41,6	0	GND	
26	44,2	0	GND	
27	46,8	0	GND	
28	51,1	6,45	DC-	
29	48,4	9,15	DC-	
30	51,1	9,15	DC-	
31	51,1	11,85	DC-	
32	51,1	14,55	DC-	
33	51,1	17,25	DC-	
34	48,4	19,95	DC-	
35	51,1	19,95	DC-	
36	51,1	22,65	DC-	
37	51,1	25,35	DC-	
38	28,6	26,95	G14	
39	32,3	26,95	S14	
40	46,05	29,35	G12	
41	49,75	29,35	S12	
42	7,35	33,6	P	
43	32,3	49,1	N	



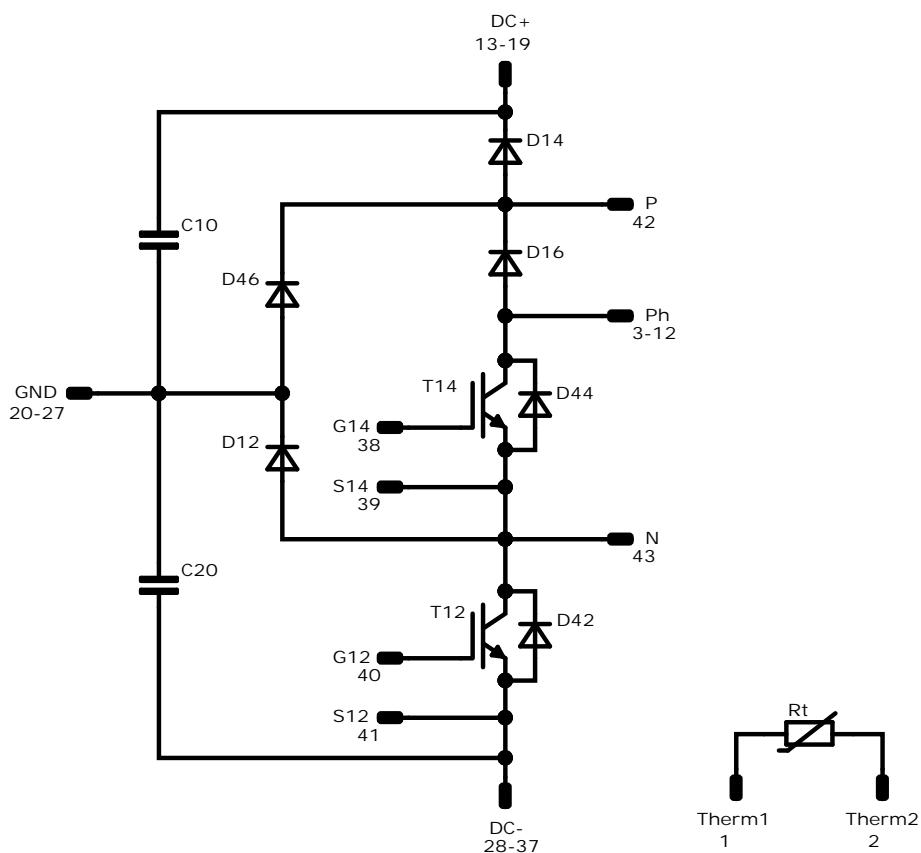
**B0-SL10NIB600S702-PA29F78Z**  
**B0-SL10NIC600S702-PA39F78Z**

Vincotech

datasheet

## Low Side Module B0-SL10NIC600S702-PA39F78Z

### Pinout



### Identification

ID	Component	Voltage	Current	Function	Comment
T12	IGBT	950 V	600 A	Buck Switch	
D12	FWD	1200 V	160 A	Buck Diode	
D42	FWD	950 V	100 A	Buck Sw. Protection Diode	
T14	IGBT	1200 V	600 A	Boost Switch	
D14	FWD	950 V	300 A	Boost Diode	
D16	FWD	1200 V	225 A	Boost Sw. Inv. Diode	
D44	FWD	1200 V	35 A	Boost Sw. Protection Diode	
D46	FWD	950 V	100 A	Boost D. Protection Diode	
C10, C20	Capacitor	1000 V		Capacitor (DC)	
Rt	Thermistor			Thermistor	

**B0-SL10NIB600S702-PA29F78Z**

datasheet

**Vincotech****Packaging instruction**

Standard packaging quantity (SPQ) 45	>SPQ	Standard	<SPQ	Sample
--------------------------------------	------	----------	------	--------

**Handling instruction**

Handling instructions for flow S3 packages see vincotech.com website.

**Package data**

Package data for flow S3 packages see vincotech.com website.

**Vincotech thermistor reference**

See Vincotech thermistor reference table at vincotech.com website.

**UL recognition and file number**

This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.



Document No.:	Date:	Modification:	Pages
B0-SL10NIx600S702-PAx9F78Z-D1-14	23 Jul. 2021		

**DISCLAIMER**

The information, specifications, procedures, methods and recommendations herein (together "information") are presented by Vincotech to reader in good faith, are believed to be accurate and reliable, but may well be incomplete and/or not applicable to all conditions or situations that may exist or occur. Vincotech reserves the right to make any changes without further notice to any products to improve reliability, function or design. No representation, guarantee or warranty is made to reader as to the accuracy, reliability or completeness of said information or that the application or use of any of the same will avoid hazards, accidents, losses, damages or injury of any kind to persons or property or that the same will not infringe third parties rights or give desired results. It is reader's sole responsibility to test and determine the suitability of the information and the product for reader's intended use.

**LIFE SUPPORT POLICY**

Vincotech products are not authorised for use as critical components in life support devices or systems without the express written approval of Vincotech.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.